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Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LCD, POR, PWM, WDT
Number of I/O	24
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	352 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 5x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f916-i-ss

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

TABLE 1-1: PIC16F91X/946 PINOUT DESCRIPTIONS (CONTINUED)

	Name	Function	Input Type	Output Type	t Description	
Vss		Vss	Р	_	Ground reference for microcontroller.	
Legend:	Legend:AN=Analog input or outputCMOS =CMOS compatible input or outputOD =Open DrainTTL=TTL compatible inputST=Schmitt Trigger input with CMOS levels P=PowerHV=High VoltageXTAL=Crystal					
Noto 1	• 1: COM3 is available on PA3 for the PIC16E013/016 and on PD0 for the PIC16E014/017 and PIC16E046					

Note 1: COM3 is available on RA3 for the PIC16F913/916 and on RD0 for the PIC16F914/917 and PIC16F946.

2: Pins available on PIC16F914/917 and PIC16F946 only.

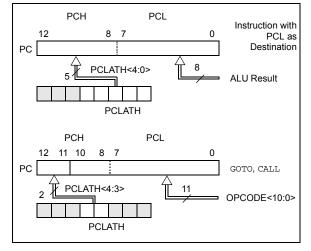
3: Pins available on PIC16F946 only.

4: I²C Schmitt trigger inputs have special input levels.

2.3 PCL and PCLATH

The Program Counter (PC) is 13 bits wide. The low byte comes from the PCL register, which is a readable and writable register. The high byte (PC<12:8>) is not directly readable or writable and comes from PCLATH. On any Reset, the PC is cleared. Figure 2-6 shows the two situations for the loading of the PC. The upper example in Figure 2-6 shows how the PC is loaded on a write to PCL (PCLATH<4:0> \rightarrow PCH). The lower example in Figure 2-6 shows how the PC is loaded during a CALL or GOTO instruction (PCLATH<4:3> \rightarrow PCH).

FIGURE 2-6: LOADING OF PC IN DIFFERENT SITUATIONS



2.3.1 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter (ADDWF PCL). When performing a table read using a computed GOTO method, care should be exercised if the table location crosses a PCL memory boundary (each 256-byte block). Refer to the Application Note AN556, *"Implementing a Table Read"* (DS00556).

2.3.2 STACK

The PIC16F91X/946 family has an 8-level x 13-bit wide hardware stack (see Figures 2-1 and 2-2). The stack space is not part of either program or data space and the Stack Pointer is not readable or writable. The PC is PUSHed onto the stack when a CALL instruction is executed or an interrupt causes a branch. The stack is POPed in the event of a RETURN, RETLW or a RETFIE instruction execution. PCLATH is not affected by a PUSH or POP operation.

The stack operates as a circular buffer. This means that after the stack has been PUSHed eight times, the ninth PUSH overwrites the value that was stored from the first PUSH. The tenth PUSH overwrites the second PUSH (and so on).

- Note 1: There are no Status bits to indicate stack overflow or stack underflow conditions.
 - 2: There are no instructions/mnemonics called PUSH or POP. These are actions that occur from the execution of the CALL, RETURN, RETLW and RETFIE instructions or the vectoring to an interrupt address.

2.4 Program Memory Paging

All PIC16F91X/946 devices are capable of addressing a continuous 8K word block of program memory. The CALL and GOTO instructions provide only 11 bits of address to allow branching within any 2K program memory page. When doing a CALL or GOTO instruction, the upper 2 bits of the address are provided by PCLATH<4:3>. When doing a CALL or GOTO instruction, the user must ensure that the page select bits are programmed so that the desired program memory page is addressed. If a return from a CALL instruction (or interrupt) is executed, the entire 13-bit PC is POPed off the stack. Therefore, manipulation of the PCLATH<4:3> bits is not required for the RETURN instructions (which POPs the address from the stack).

Note:	The contents of the PCLATH register are unchanged after a RETURN or RETFIE instruction is executed. The user must rewrite the contents of the PCLATH regis- ter for any subsequent subroutine calls or GOTO instructions.
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Example 2-1 shows the calling of a subroutine in page 1 of the program memory. This example assumes that PCLATH is saved and restored by the Interrupt Service Routine (if interrupts are used).

EXAMPLE 2-1: CALL OF A SUBROUTINE IN PAGE 1 FROM PAGE 0

	ORG 500h	
	BCF PCLATH,4	
	BSF PCLATH,3	;Select page 1 ;(800h-FFFh)
	CALL SUB1_P1	;Call subroutine in
	: –	;page 1 (800h-FFFh)
	:	
	ORG 900h	;page 1 (800h-FFFh)
SUB1_P1		
	:	;called subroutine
		;page 1 (800h-FFFh)
	:	
	RETURN	;return to
		;Call subroutine
		;in page 0
		;(000h-7FFh)

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
LCDCON	LCDEN	SLPEN	WERR	VLCDEN	CS1	CS0	LMUX1	LMUX0	0001 0011	0001 0011
LCDSE4 ⁽¹⁾	SE39	SE38	SE37	SE36	SE35	SE34	SE33	SE32	0000 0000	uuuu uuuu
LCDSE5 ⁽¹⁾	_	_	—	_	—	—	SE41	SE40	00	uu
PORTG ⁽¹⁾	_	—	RG5	RG4	RG3	RG2	RG1	RG0	xx xxxx	uu uuuu
TRISG ⁽¹⁾	_	_	TRISG5	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	11 1111	11 1111

TABLE 3-7: SUMMARY OF REGISTERS ASSOCIATED WITH PORTG⁽¹⁾

 Legend:
 x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by PORTG.

 Note
 1:
 PIC16F946 only.

4.5.3 LFINTOSC

The Low-Frequency Internal Oscillator (LFINTOSC) is an uncalibrated 31 kHz internal clock source.

The output of the LFINTOSC connects to a postscaler and multiplexer (see Figure 4-1). Select 31 kHz, via software, using the IRCF<2:0> bits of the OSCCON register. See **Section 4.5.4 "Frequency Select Bits (IRCF)**" for more information. The LFINTOSC is also the frequency for the Power-up Timer (PWRT), Watchdog Timer (WDT) and Fail-Safe Clock Monitor (FSCM).

The LFINTOSC is enabled by selecting 31 kHz (IRCF<2:0> bits of the OSCCON register = 000) as the system clock source (SCS bit of the OSCCON register = 1), or when any of the following are enabled:

- Two-Speed Start-up IESO bit of the Configuration Word register = 1 and IRCF<2:0> bits of the OSCCON register = 000
- Power-up Timer (PWRT)
- Watchdog Timer (WDT)
- Fail-Safe Clock Monitor (FSCM)

The LF Internal Oscillator (LTS) bit of the OSCCON register indicates whether the LFINTOSC is stable or not.

4.5.4 FREQUENCY SELECT BITS (IRCF)

The output of the 8 MHz HFINTOSC and 31 kHz LFINTOSC connects to a postscaler and multiplexer (see Figure 4-1). The Internal Oscillator Frequency Select bits IRCF<2:0> of the OSCCON register select the frequency output of the internal oscillators. One of eight frequencies can be selected via software:

- 8 MHz
- 4 MHz (Default after Reset)
- 2 MHz
- 1 MHz
- 500 kHz
- 250 kHz
- 125 kHz
- 31 kHz (LFINTOSC)

Note:	Following any Reset, the IRCF<2:0> bits of
	the OSCCON register are set to '110' and
	the frequency selection is set to 4 MHz.
	The user can modify the IRCF bits to
	select a different frequency.

4.5.5 HF AND LF INTOSC CLOCK SWITCH TIMING

When switching between the LFINTOSC and the HFINTOSC, the new oscillator may already be shut down to save power (see Figure 4-6). If this is the case, there is a delay after the IRCF<2:0> bits of the OSCCON register are modified before the frequency selection takes place. The LTS and HTS bits of the OSCCON register will reflect the current active status of the LFINTOSC and HFINTOSC oscillators. The timing of a frequency selection is as follows:

- 1. IRCF<2:0> bits of the OSCCON register are modified.
- 2. If the new clock is shut down, a clock start-up delay is started.
- 3. Clock switch circuitry waits for a falling edge of the current clock.
- 4. CLKOUT is held low and the clock switch circuitry waits for a rising edge in the new clock.
- CLKOUT is now connected with the new clock. LTS and HTS bits of the OSCCON register are updated as required.
- 6. Clock switch is complete.

See Figure 4-1 for more details.

If the internal oscillator speed selected is between 8 MHz and 125 kHz, there is no start-up delay before the new frequency is selected. This is because the old and new frequencies are derived from the HFINTOSC via the postscaler and multiplexer.

Start-up delay specifications are located under the oscillator parameters of **Section 19.0** "**Electrical Specifications**".

5.1.3 SOFTWARE PROGRAMMABLE PRESCALER

A single software programmable prescaler is available for use with either Timer0 or the Watchdog Timer (WDT), but not both simultaneously. The prescaler assignment is controlled by the PSA bit of the Option register. To assign the prescaler to Timer0, the PSA bit must be cleared to a '0'.

There are 8 prescaler options for the Timer0 module ranging from 1:2 to 1:256. The prescale values are selectable via the PS<2:0> bits of the OPTION register. In order to have a 1:1 prescaler value for the Timer0 module, the prescaler must be assigned to the WDT module.

The prescaler is not readable or writable. When assigned to the Timer0 module, all instructions writing to the TMR0 register will clear the prescaler.

When the prescaler is assigned to WDT, a CLRWDT instruction will clear the prescaler along with the WDT.

5.1.3.1 Switching Prescaler Between Timer0 and WDT Modules

As a result of having the prescaler assigned to either Timer0 or the WDT, it is possible to generate an unintended device Reset when switching prescaler values. When changing the prescaler assignment from Timer0 to the WDT module, the instruction sequence shown in Example 5-1, must be executed.

EXAMPLE 5-1: CHANGING PRESCALER (TIMER0 \rightarrow WDT)

BANKSEL	TMR 0	
CLRWDT	IMICO	, ;Clear WDT
CLRF	TMR 0	;Clear TMR0 and
CLIKF	IMRO	
		;prescaler
BANKSEL	OPTION_REG	;
BSF	OPTION_REG, PSA	;Select WDT
CLRWDT		;
		;
MOVLW	b'11111000'	;Mask prescaler
ANDWF	OPTION_REG,W	;bits
IORLW	b'00000101'	;Set WDT prescaler
MOVWF	OPTION_REG	;to 1:32

When changing the prescaler assignment from the WDT to the Timer0 module, the following instruction sequence must be executed (see Example 5-2).

EXAMPLE 5-2:	CHANGING PRESCALER
	(WDT \rightarrow TIMER0)

CLRWDT		;Clear WDT and ;prescaler
DANKGET	OPTION REG	, presearer
DANKSEL	OFIION_REG	i
MOVLW	b'11110000'	;Mask TMR0 select and
ANDWF	OPTION_REG,W	;prescaler bits
IORLW	b'00000011'	;Set prescale to 1:16
MOVWF	OPTION_REG	i

5.1.4 TIMER0 INTERRUPT

Timer0 will generate an interrupt when the TMR0 register overflows from FFh to 00h. The T0IF interrupt flag bit of the INTCON register is set every time the TMR0 register overflows, regardless of whether or not the Timer0 interrupt is enabled. The T0IF bit must be cleared in software. The Timer0 interrupt enable is the T0IE bit of the INTCON register.

Note:	The Timer0 interrupt cannot wake the
	processor from Sleep since the timer is
	frozen during Sleep.

5.1.5 USING TIMER0 WITH AN EXTERNAL CLOCK

When Timer0 is in Counter mode, the synchronization of the T0CKI input and the Timer0 register is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks. Therefore, the high and low periods of the external clock source must meet the timing requirements as shown in Section 19.0 "Electrical Specifications"

6.7 Timer1 Interrupt

The Timer1 register pair (TMR1H:TMR1L) increments to FFFFh and rolls over to 0000h. When Timer1 rolls over, the Timer1 interrupt flag bit of the PIR1 register is set. To enable the interrupt on rollover, you must set these bits:

- · Timer1 interrupt enable bit of the PIE1 register
- · PEIE bit of the INTCON register
- · GIE bit of the INTCON register

The interrupt is cleared by clearing the TMR1IF bit in the Interrupt Service Routine.

Note:	The TMR1H:TMR1L register pair and th	е
	TMR1IF bit should be cleared befor	e
	enabling interrupts.	

6.8 Timer1 Operation During Sleep

Timer1 can only operate during Sleep when setup in Asynchronous Counter mode. In this mode, an external crystal or clock source can be used to increment the counter. To set up the timer to wake the device:

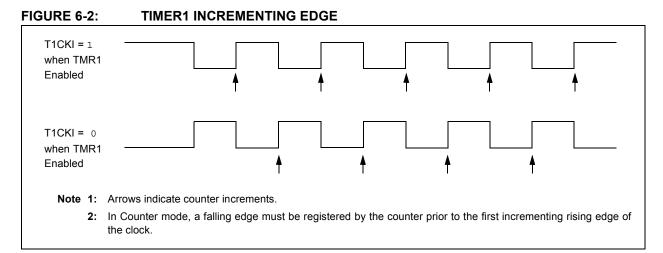
- TMR1ON bit of the T1CON register must be set
- TMR1IE bit of the PIE1 register must be set
- · PEIE bit of the INTCON register must be set

The device will wake-up on an overflow and execute the next instruction. If the GIE bit of the INTCON register is set, the device will call the Interrupt Service Routine (0004h).

6.9 Clock Source for LCD Module

The Timer1 oscillator can be used to provide a clock for the LCD module. This clock may be configured to remain running during Sleep.

For more information, see Section 10.0 "Liquid Crystal Display (LCD) Driver Module".



8.2 Comparator Configuration

There are eight modes of operation for the comparator. The CM<2:0> bits of the CMCON0 register are used to select these modes as shown in Figure 8-5. I/O lines change as a function of the mode and are designated as follows:

- Analog function (A): digital input buffer is disabled
- Digital function (D): comparator digital output, overrides port function
- Normal port function (I/O): independent of comparator

The port pins denoted as "A" will read as a '0' regardless of the state of the I/O pin or the I/O control TRIS bit. Pins used as analog inputs should also have the corresponding TRIS bit set to '1' to disable the digital output driver. Pins denoted as "D" should have the corresponding TRIS bit set to '0' to enable the digital output driver.

Note:	Comparator interrupts should be disabled
	during a Comparator mode change to
	prevent unintended interrupts.

TABLE 12-1: ADC CLOCK PERIOD (TAD) Vs. DEVICE OPERATING FREQUENCIES (VDD > 3.0V)

ADC Clock	Period (TAD)	Device Frequency (Fosc)					
ADC Clock Source	ADCS<2:0>	20 MHz	8 MHz	4 MHz	1 MHz		
Fosc/2	000	100 ns ⁽²⁾	250 ns ⁽²⁾	500 ns ⁽²⁾	2.0 μs		
Fosc/4	100	200 ns ⁽²⁾	500 ns ⁽²⁾	1.0 μs ⁽²⁾	4.0 μs		
Fosc/8	001	400 ns ⁽²⁾	1.0 μs ⁽²⁾	2.0 μs	8.0 μs ⁽³⁾		
Fosc/16	101	800 ns ⁽²⁾	2.0 μs	4.0 μs	16.0 μs ⁽³⁾		
Fosc/32	010	1.6 μs	4.0 μs	8.0 μs ⁽³⁾	32.0 μs ⁽³⁾		
Fosc/64	110	3.2 μs	8.0 μs ⁽³⁾	16.0 μs ⁽³⁾	64.0 μs ⁽³⁾		
Frc	x11	2-6 μs ^(1,4)	2-6 μs ^(1,4)	2-6 μs ^(1,4)	2-6 μs ^(1,4)		

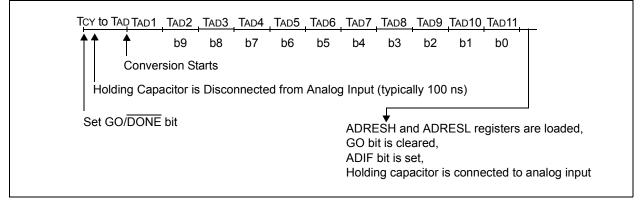
Legend: Shaded cells are outside of recommended range.

Note 1: The FRC source has a typical TAD time of 4 μ s for VDD > 3.0V.

2: These values violate the minimum required TAD time.

- **3:** For faster conversion times, the selection of another clock source is recommended.
- 4: When the device frequency is greater than 1 MHz, the FRC clock source is only recommended if the conversion will be performed during Sleep.

FIGURE 12-2: ANALOG-TO-DIGITAL CONVERSION TAD CYCLES



12.1.5 INTERRUPTS

The ADC module allows for the ability to generate an interrupt upon completion of an Analog-to-Digital conversion. The ADC interrupt flag is the ADIF bit in the PIR1 register. The ADC interrupt enable is the ADIE bit in the PIE1 register. The ADIF bit must be cleared in software.

Note:	The ADIF bit is set at the completion of
	every conversion, regardless of whether
	or not the ADC interrupt is enabled.

This interrupt can be generated while the device is operating or while in Sleep. If the device is in Sleep, the interrupt will wake-up the device. Upon waking from Sleep, the next instruction following the SLEEP instruction is always executed. If the user is attempting to wake-up from Sleep and resume in-line code execution, the global interrupt must be disabled. If the global interrupt is enabled, execution will switch to the Interrupt Service Routine.

Please see **Section 12.1.5** "Interrupts" for more information.

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R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0				
ADFM	VCFG1	VCFG0	CHS2	CHS1	CHS0	GO/DONE	ADON				
bit 7				•			bit				
Legend:											
R = Readable	a hit	W = Writable	hit	LI – Unimploy	mented bit, rea	ad aa 'O'					
-n = Value at		'1' = Bit is set		0 – Onimpier		x = Bit is unkn	014/2				
	PUR	I = BILIS SEL			areu		JWII				
bit 7	ADFM: A/D	Conversion Res	ult Format Se	lect bit							
	1 = Right jus										
	0 = Left justi	fied									
bit 6	VCFG1: Vol	tage Reference	bit								
	1 = VREF- pi	n									
	0 = V SS										
bit 5		tage Reference	bit								
	1 = VREF+ p	in									
	0 = Vss										
bit 4-2		Analog Channel	Select bits								
	000 = AN0 001 = AN1										
	001 = AN1 010 = AN2										
	011 = AN3										
	100 = AN4										
	101 = AN5⁽¹										
	110 = AN6 ⁽¹ 111 = AN7 ⁽¹										
			o								
bit 1		A/D Conversion									
		 A/D conversion cycle in progress. Setting this bit starts an A/D conversion cycle. This bit is automatically cleared by hardware when the A/D conversion has completed. 									
		version complete			e A/D convers		eu.				
bit 0	ADON: ADO	•	samet in prog								
~	1 = ADC is e										
	0 = ADC is c										

REGISTER 12-1: ADCON0: A/D CONTROL REGISTER 0

Note 1: Not available on 28-pin devices.

REGISTER 14-2: SSPCON: SYNC SERIAL PORT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WCOL	SSPOV	SSPEN	CKP	SSPM3 ⁽²⁾	SSPM2 ⁽²⁾	SSPM1 ⁽²⁾	SSPM0 ⁽²⁾
bit 7							bit (
Logondy							
Legend: R = Readable b	it	W = Writable bit		U = Unimpleme	ented bit, read as	ʻ0'	
-n = Value at PC		'1' = Bit is set		'0' = Bit is clear		x = Bit is unkno	מאונ
							,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,
bit 7		Collision Detect bit SUF register is writ		till transmitting the	e previous word (I	must be cleared i	n software)
bit 6	In SPI mode: 1 = A new byt data in SS transmittin tion (and t 0 = No overflo In I ² C [™] mode: 1 = A byte is b	received while the node. SSPOV mu	e the SSPBUI flow can only o etting overflow itiated by writin e SSPBUF reg	occur in Slave mode . In Master mode ng to the SSPBU gister is still holdi	ode. The user mu e, the overflow bit F register. Ing the previous	st read the SSPE is not set since e	BUF, even if only each new recep
bit 5	In SPI mode: 1 = Enables se 0 = Disables se In I ² C mode: 1 = Enables the 0 = Disables se	ronous Serial Por rial port and confi erial port and conf e serial port and c erial port and conf when enabled, th	gures SCK, SI igures these p onfigures the s igures these p	ins as I/O port pi SDA and SCL pir ins as I/O port pi	ns ns as serial port p ns		
bit 4	CKP : Clock Po In SPI mode: 1 = Idle state fo	larity Select bit or clock is a high le or clock is a low le	evel (Microwire	e default)		i ouput.	
	1 = Enable cloc		n). (Used to er	isure data setup	time.)		
bit 3-0	$\begin{array}{l} 0000 = {\rm SPI} \mbox{ Ma} \\ 0001 = {\rm SPI} \mbox{ Ma} \\ 0010 = {\rm SPI} \mbox{ Ma} \\ 0011 = {\rm SPI} \mbox{ Ma} \\ 0100 = {\rm SPI} \mbox{ SIa} \\ 0101 = {\rm SPI} \mbox{ SIa} \\ 0101 = {\rm I}^2 {\rm C} \mbox{ SIa} \\ 0111 = {\rm I}^2 {\rm C} \mbox{ SIa} \\ 1000 = {\rm Reserv} \\ 1001 = {\rm Reserv} \\ 1010 = {\rm Reserv} \\ 1011 = {\rm I}^2 {\rm C} \mbox{ Firm} \\ 1100 = {\rm Reserv} \\ 1101 = {\rm Reserv} \\ 1100 = {\rm SIa} \\ {\rm SIa} \mbox{ SIa} \mbox{ SIa} \mbox{ SIa} \mbox{ SIa} \\ {\rm SIa} \mbox{ SIa} S$	ed ed nware Controlled ed	= Fosc/4 = Fosc/16 = Fosc/64 = TMR2 outpu SCK pin. SS SCK pin. SS dress ddress Master mode	t/2 pin control enable pin control disabl (slave IDLE) rt and Stop bit int	ed. SS can be us terrupts enabled		

14.2 Operation

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits (SSPCON<5:0> and SSPSTAT<7:6>). These control bits allow the following to be specified:

- Master mode (SCK is the clock output)
- · Slave mode (SCK is the clock input)
- Clock Polarity (Idle state of SCK)
- Data Input Sample Phase (middle or end of data output time)
- Clock Edge (output data on rising/falling edge of SCK)
- Clock Rate (Master mode only)
- · Slave Select mode (Slave mode only)

The SSP consists of a transmit/receive shift register (SSPSR) and a buffer register (SSPBUF). The SSPSR shifts the data in and out of the device, MSb first. The SSPBUF holds the data that was written to the SSPSR until the received data is ready. Once the eight bits of data have been received, that byte is moved to the SSPBUF register. Then, the Buffer Full Status bit BF of the SSPSTAT register, and the interrupt flag bit SSPIF, are set. Any write to the SSPBUF register during transmission/reception of data will be ignored and the Write Collision Detect bit, WCOL of the SSPCON register, will be set. User software must clear the WCOL bit so that it can be determined if the following write(s) to the SSPBUF register completed successfully.

When the application software is expecting to receive valid data, the SSPBUF should be read before the next byte of data to transfer is written to the SSPBUF. Buffer Full bit BF of the SSPSTAT register indicates when SSPBUF has been loaded with the received data (transmission is complete). When the SSPBUF is read, the BF bit is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally, the SSP interrupt is used to determine when the transmission/reception has completed. The SSPBUF must be read and/or written. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur. Example 14-1 shows the loading of the SSPBUF (SSPSR) for data transmission.

The SSPSR is not directly readable or writable and can only be accessed by addressing the SSPBUF register. Additionally, the SSP STATUS register (SSPSTAT) indicates the various status conditions.

EXAMPLE 14-1: LOADING THE SSPBUF (SSPSR) REGISTER

LOOP	BANKSEL	SSPSTAT	;
	BTFSS	SSPSTAT, BF	;Has data been received(transmit complete)?
	GOTO	LOOP	;No
	BANKSEL	SSPBUF	;
	MOVF	SSPBUF, W	;WREG reg = contents of SSPBUF
	MOVF	RXDATA	;Save in user RAM, if data is meaningful
	MOVF	TXDATA, W	;W reg = contents of TXDATA
	MOVF	SSPBUF	;New data to xmit

14.13 Master Mode

Master mode of operation is supported in firmware using interrupt generation on the detection of the Start and Stop conditions. The Stop (P) and Start (S) bits are cleared from a Reset or when the SSP module is disabled. The Stop (P) and Start (S) bits will toggle based on the Start and Stop conditions. Control of the I^2C bus may be taken when the P bit is set or the bus is idle and both the S and P bits are clear.

In Master mode, the SCL and SDA lines are manipulated by clearing the corresponding TRISC<7,6> bit(s). The output level is always low, irrespective of the value(s) in PORTC<7,6>. So when transmitting data, a '1' data bit must have the TRISC<6> bit set (input) and a '0' data bit must have the TRISC<7> bit cleared (output). The same scenario is true for the SCL line with the TRISC<6> bit. Pull-up resistors must be provided externally to the SCL and SDA pins for proper operation of the I²C module.

The following events will cause the SSP Interrupt Flag bit, SSPIF, to be set (SSP Interrupt will occur if enabled):

- Start condition
- Stop condition
- Data transfer byte transmitted/received

Master mode of operation can be done with either the Slave mode idle (SSPM<3:0> = 1011), or with the Slave active. When both Master and Slave modes are enabled, the software needs to differentiate the source(s) of the interrupt.

14.14 Multi-Master Mode

In Multi-Master mode, the interrupt generation on the detection of the Start and Stop conditions, allows the determination of when the bus is free. The Stop (P) and Start (S) bits are cleared from a Reset or when the SSP module is disabled. The Stop (P) and Start (S) bits will toggle based on the Start and Stop conditions. Control of the I^2C bus may be taken when bit P (SSPSTAT<4>) is set, or the bus is idle and both the S and P bits clear. When the bus is busy, enabling the SSP Interrupt will generate the interrupt when the Stop condition occurs.

In Multi-Master operation, the SDA line must be monitored to see if the signal level is the expected output level. This check only needs to be done when a high level is output. If a high level is expected and a low level is present, the device needs to release the SDA and SCL lines (set TRISC<7,6>). There are two stages where this arbitration can be lost, these are:

- · Address Transfer
- Data Transfer

When the slave logic is enabled, the slave continues to receive. If arbitration was lost during the address transfer stage, communication to the device may be in progress. If addressed, an ACK pulse will be generated. If arbitration was lost during the data transfer stage, the device will need to re-transfer the data at a later time.

14.14.1 CLOCK SYNCHRONIZATION AND THE CKP BIT

When the CKP bit is cleared, the SCL output is forced to '0'; however, setting the CKP bit will not assert the SCL output low until the SCL output is already sampled low. Therefore, the CKP bit will not assert the SCL line until an external l^2C master device has already asserted the SCL line. The SCL output will remain low until the CKP bit is set and all other devices on the l^2C bus have deasserted SCL. This ensures that a write to the CKP bit will not violate the minimum high time requirement for SCL (see Figure 14-12).

TABLE 16-4: INITIALIZATION CONDITION FOR REGISTERS (CONTINUED)

Register	Address	Power-on Reset	 MCLR Reset WDT Reset Brown-out Reset⁽¹⁾ 	 Wake-up from Sleep through interrupt Wake-up from Sleep through WDT time-out
LCDDATA22 ⁽⁷⁾	19Ah	XXXX XXXX	uuuu uuuu	uuuu uuuu
LCDDATA23 ⁽⁷⁾	19Bh	xx	uu	uu
LCDSE3 ⁽⁷⁾	19Ch	0000 0000	uuuu uuuu	uuuu uuuu
LCDSE4 ⁽⁷⁾	19Dh	0000 0000	uuuu uuuu	uuuu uuuu
LCDSE5 ⁽⁷⁾	19Eh	00	uu	uu
EECON1	18Ch	x x000	u q000	u uuuu

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0', q = value depends on condition.

Note 1: If VDD goes too low, Power-on Reset will be activated and registers will be affected differently.

- 2: One or more bits in INTCON and/or PIR1 will be affected (to cause wake-up).
- **3:** When the wake-up is due to an interrupt and the GIE bit is set, the PC is loaded with the interrupt vector (0004h).
- 4: See Table 16-5 for Reset value for specific condition.
- 5: If Reset was due to brown-out, then bit 0 = 0. All other Resets will cause bit 0 = u.
- 6: PIC16F914/917 and PIC16F946 only.
- 7: PIC16F946 only.

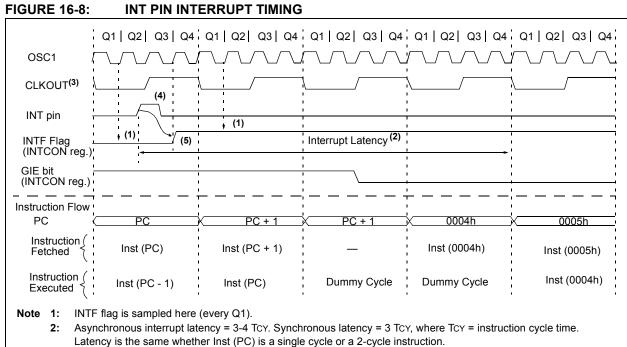
TABLE 16-5: INITIALIZATION CONDITION FOR SPECIAL REGISTERS

Condition	Program Counter	STATUS Register	PCON Register	
Power-on Reset	0000h	0001 1xxx	10x	
MCLR Reset during normal operation	0000h	000u uuuu	uuu	
MCLR Reset during Sleep	0000h	0001 0uuu	uuu	
WDT Reset	0000h	0000 uuuu	uuu	
WDT Wake-up	PC + 1	uuu0 0uuu	uuu	
Brown-out Reset	0000h	0001 luuu	110	
Interrupt Wake-up from Sleep	PC + 1 ⁽¹⁾	uuul 0uuu	uuu	

Legend: u = unchanged, x = unknown, - = unimplemented bit, reads as '0'.

Note 1: When the wake-up is due to an interrupt and Global Interrupt Enable bit, GIE, is set, the PC is loaded with the interrupt vector (0004h) after execution of PC + 1.

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- 3: CLKOUT is available only in INTOSC and RC Oscillator modes.
- 4: For minimum width of INT pulse, refer to AC specifications in Section 19.0 "Electrical Specifications".
- 5: INTF is enabled to be set any time during the Q4-Q1 cycles.

TABLE 16-6: SUMMARY OF INTERRUPT REGISTERS	
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Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
INTCON	GIE	PEIE	TOIE	INTE	RBIE	T0IF	INTF	RBIF	x000 0000	0000 000x
PIR1	EEIF	ADIF	RCIF	TXIF	SSPIF	CCP1IF	TMR2IF	TMR1IF	0000 0000	0000 0000
PIR2	OSFIF	C2IF	C1IF	LCDIF	-	LVDIF	-	CCP2IF	0000 -0-0	0000 - 0 - 0
PIE1	EEIE	ADIE	RCIE	TXIE	SSPIE	CCP1IE	TMR2IE	TMR1IE	0000 0000	0000 0000
PIE2	OSFIE	C2IE	C1IE	LCDIE	_	LVDIE	_	CCP2IE	0000 -0-0	0000 -0-0

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by the Interrupt Module.

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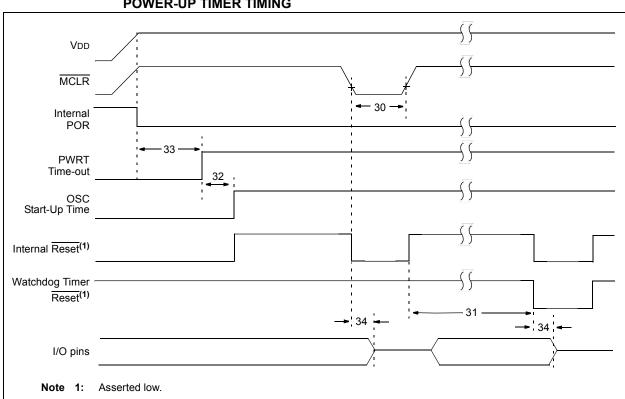
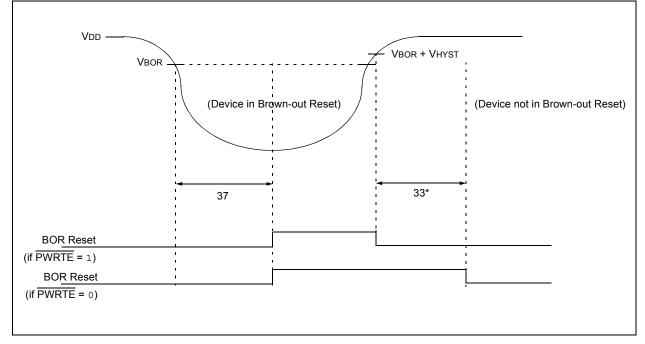


FIGURE 19-6: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING





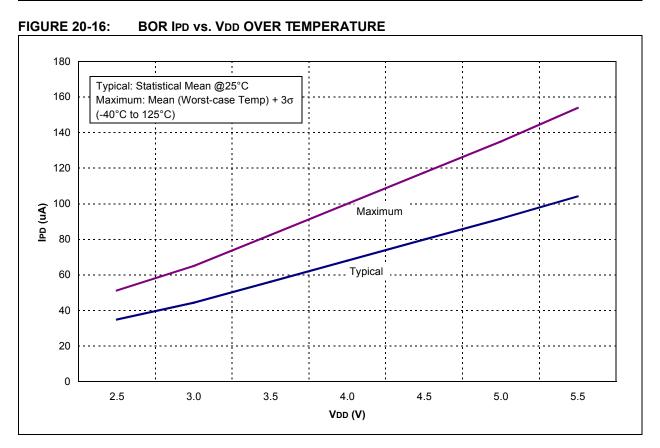
DC CHARACTERISTICS			Standard Operating Operating	Tempera	ture -40°C	s (unless othe ≤ Ta ≤ +125°C ange 2.0V-5.5	;	ated)
Sym. Characteristic		Min.	Тур†	Max. (85°C)	Max. (125°C)	Units	Conditions	
Vplvd	PLVD	LVDL<2:0> = 001	1.900	2.0	2.100	2.125	V	
	Voltage	LVDL<2:0> = 010	2.000	2.1	2.200	2.225	V	
		LVDL<2:0> = 011	2.100	2.2	2.300	2.325	V	
		LVDL<2:0> = 100	2.200	2.3	2.400	2.425	V	
		LVDL<2:0> = 101	3.825	4.0	4.175	4.200	V	
		LVDL<2:0> = 110	4.025	4.2	4.375	4.400	V	
		LVDL<2:0> = 111	4.425	4.5	4.675	4.700	V	
*TPLVDS	*TPLVDS PLVD Settling time			50 25		_	μs	VDD = 5.0V VDD = 3.0V

TABLE 19-13: PIC16F913/914/916/917/946 PLVD CHARACTERISTICS:

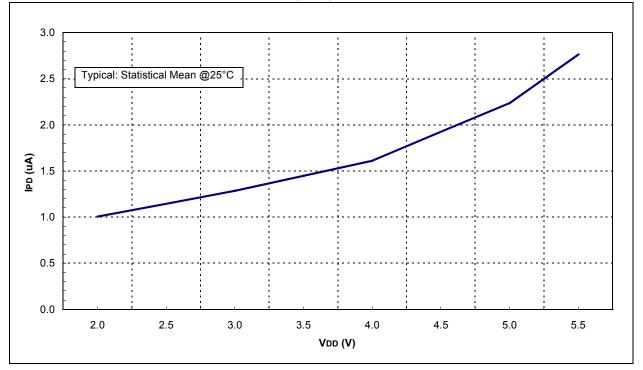
* These parameters are characterized but not tested

† Data in "Typ" column is at 5.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

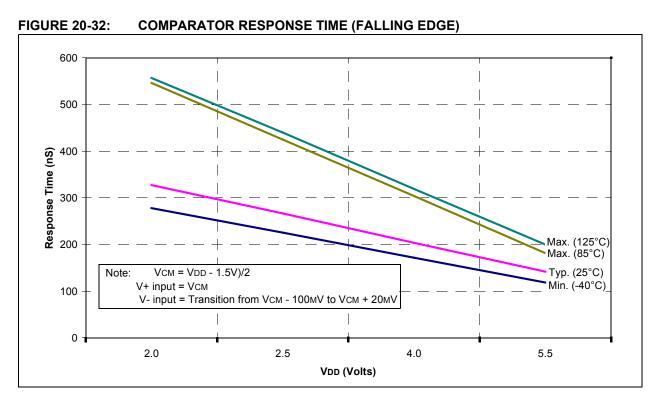
PIC16F913/914/916/917/946



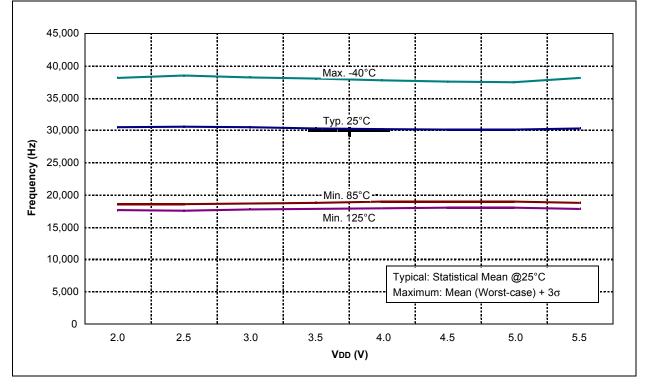




PIC16F913/914/916/917/946







Package Marking Information (Continued)

44-Lead QFN



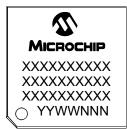
28-Lead SOIC



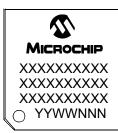
28-Lead SSOP



44-Lead TQFP



64-Lead TQFP (10x10x1mm)



Example



Example



Example



Example



Example

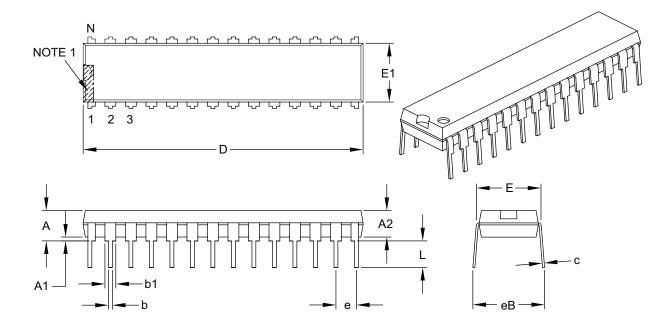


21.2 Package Details

The following sections give the technical details of the packages.

28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	INCHES			
Dir	mension Limits	MIN	NOM	MAX	
Number of Pins	N		28		
Pitch	е		.100 BSC		
Top to Seating Plane	А	-	-	.200	
Molded Package Thickness	A2	.120	.135	.150	
Base to Seating Plane	A1	.015	-	-	
Shoulder to Shoulder Width	E	.290	.310	.335	
Molded Package Width	E1	.240	.285	.295	
Overall Length	D	1.345	1.365	1.400	
Tip to Seating Plane	L	.110	.130	.150	
Lead Thickness	С	.008	.010	.015	
Upper Lead Width	b1	.040	.050	.070	
Lower Lead Width	b	.014	.018	.022	
Overall Row Spacing §	eB	-	-	.430	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B